

December 2015

FDP075N15A / FDB075N15A N-Channel PowerTrench® MOSFET 150 V, 130 A, 7.5 m Ω

Features

- $R_{DS(on)}$ = 6.25 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 100 A
- · Fast Switching
- · Low Gate Charge
- High Performance Trench Technology for Extremely Low R_{DS(on)}
- · High Power and Current Handling Capability
- · RoHS Compliant

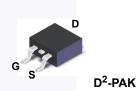
Description

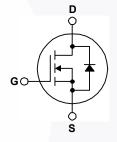
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Synchronous Rectification for ATX / Server / Telecom PSU
- · Battery Protection Circuit
- · Motor Drives and Uninterruptible Power Supplies
- · Micro Solar Inverter







MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter			FDP075N15A_F102 FDB075N15A	Unit	
V _{DSS}	Drain to Source Voltage			150	V	
V	Cata to Source Voltage	- DC		±20	V	
V _{GSS} Gate to Source Voltage	- AC	(f > 1 Hz)	±30	v		
I _D	Drain Current	- Continuous (T _C = 25°C)		130*	A	
	Diam Current	- Continuous (T _C = 100°C)		92		
I _{DM}	Drain Current	- Pulsed	- Pulsed (Note 1)			
E _{AS}	Single Pulsed Avalanche Energy (Note		(Note 2)	588	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	6.0	V/ns	
D	Dower Dissination	$(T_C = 25^{\circ}C)$		333	W	
P_D	Power Dissipation	- Derate Above 25°C		2.22	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +175	οС		
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

^{*} Package limitation current is 120 A.

Thermal Characteristics

Symbol	Parameter	FDP075N15A_F102 FDB075N15A	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	0.45	
D	Thermal Resistance, Junction to Ambient (Minimum Pad of 2-oz Copper), Max.	62.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, D2-PAK (1 in ² Pad of 2-oz Copper), Max.	40	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDP075N15A_F102	FDP075N15A	TO-220	Tube	N/A	N/A	50 units
FDB075N15A	FDB075N15A	D ² -PAK	Tape and Reel	330 mm	24 mm	800 units

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 \text{V}$	150	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, Referenced to 25°C	-	0.1	-	V/°C
	Zero Gate Voltage Drain Current	V _{DS} = 120 V, V _{GS} = 0 V	-	-	1	^
I _{DSS}	Zero Gate voltage Drain Current	$V_{DS} = 120 \text{ V}, T_{C} = 150^{\circ}\text{C}$	-	-	500	μΑ
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	-	4.0	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 100 A	-	6.25	7.5	$m\Omega$
9 _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 100 A	-	164	1	S

Dynamic Characteristics

C _{iss}	Input Capacitance	75.77.77		-	5525	7350	pF
Coss	Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V, f = 1 MHz		-\	516	685	pF
C _{rss}	Reverse Transfer Capacitance			- \	21	-	pF
C _{oss(er)}	Energy Related Output Capacitance	V _{DS} = 75 V, V _{GS} = 0 V		- \	909	-	pF
Q _{g(tot)}	Total Gate Charge at 10V			-	77	100	nC
Q_{gs}	Gate to Source Gate Charge V _{DS} = 75 V, I _D = 100 A,			-	26	-	nC
Q _{gs2}	Gate Charge Threshold to Plateau V _{GS} = 10 V			-	11	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	()	Note 4)	-	16	-	nC
ESR	Equivalent Series Resistance(G-S)	f = 1 MHz		-	2.29	-	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time		-	28	66	ns
t _r	Turn-On Rise Time	$V_{DD} = 75 \text{ V}, I_D = 100 \text{ A},$	-	37	84	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{G} = 4.7 \Omega$	_	62	134	ns
t _f	Turn-Off Fall Time	(Note 4)	-	21	52	ns

Drain-Source Diode Characteristics

Is	Maximum Continuous Drain to Source Diode Forward Current		-	130*	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	520	Α
V_{SD}	Drain to Source Diode Forward Voltage $V_{GS} = 0 \text{ V}, I_{SD} = 100 \text{ M}$) A -	-	1.25	V
t _{rr}	Reverse Recovery Time $V_{GS} = 0 \text{ V}, V_{DD} = 79$	5 V, I _{SD} = 100 A, -	97	-	ns
Q _{rr}	Reverse Recovery Charge $dI_F/dt = 100 A/\mu s$	-	264	//-	nC

Notes

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. Starting $T_J = 25$ °C, L = 3 mH, $I_{AS} = 19.8$ A.
- 3. I $_{SD} \leq$ 100 A, di/dt \leq 200 A/µs, V $_{DD} \leq$ BV $_{DSS},$ starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.

Typical Performance Characteristics

Figure 1. On-Region Characteristics

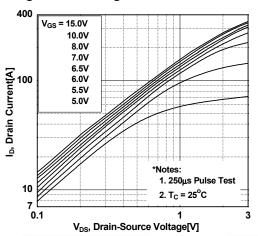


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

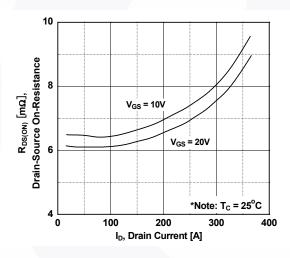


Figure 5. Capacitance Characteristics

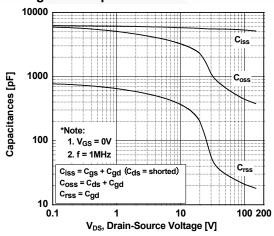


Figure 2. Transfer Characteristics

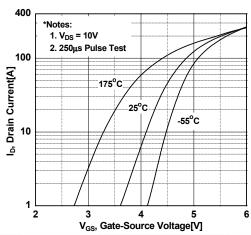


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

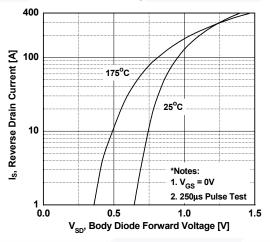
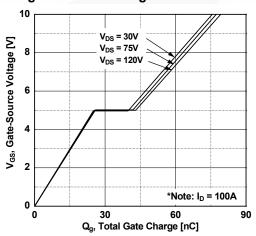


Figure 6. Gate Charge Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

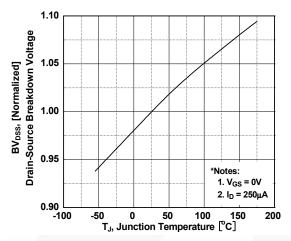


Figure 9. Maximum Safe Operating Area

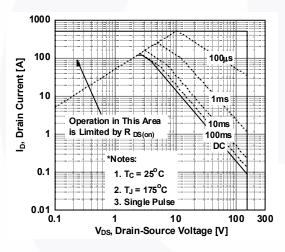


Figure 11. Eoss vs. Drain to Source Voltage

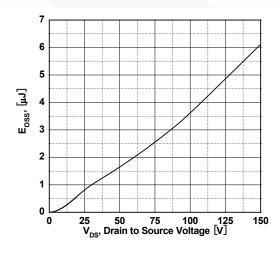


Figure 8. On-Resistance Variation vs. Temperature

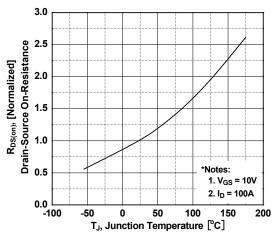


Figure 10. Maximum Drain Current vs. Case Temperature

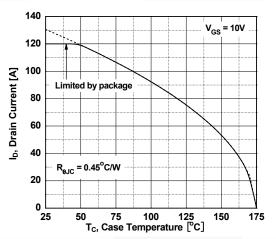
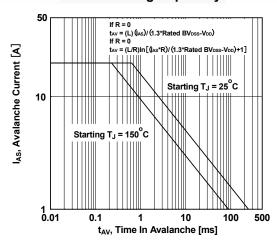
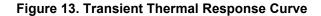
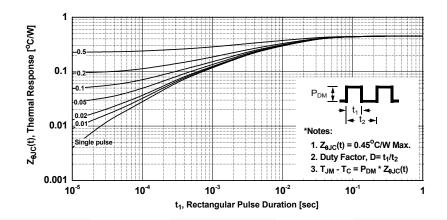


Figure 12. Unclamped Inductive Switching Capability



Typical Performance Characteristics (Continued)





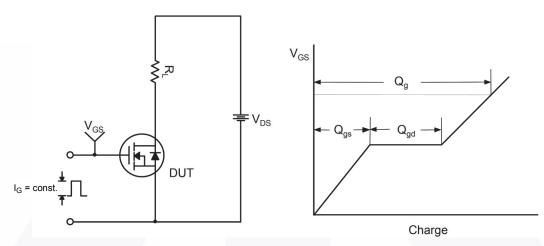


Figure 14. Gate Charge Test Circuit & Waveform

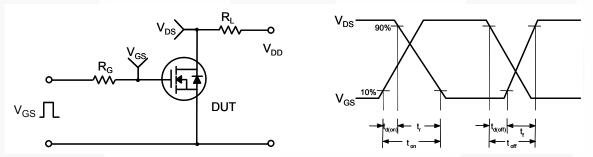


Figure 15. Resistive Switching Test Circuit & Waveforms

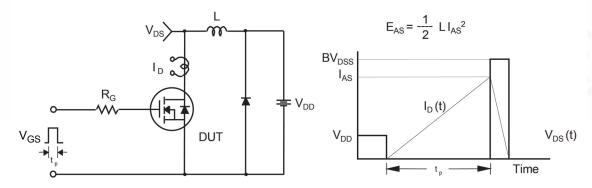


Figure 16. Unclamped Inductive Switching Test Circuit & Waveforms

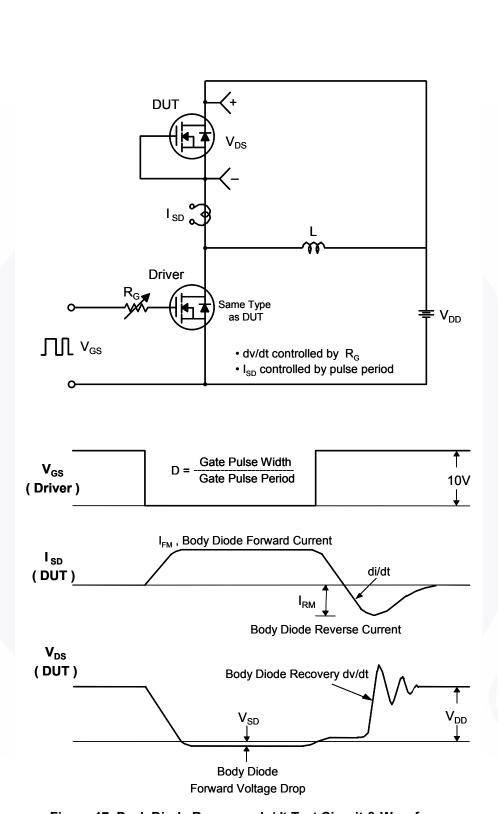
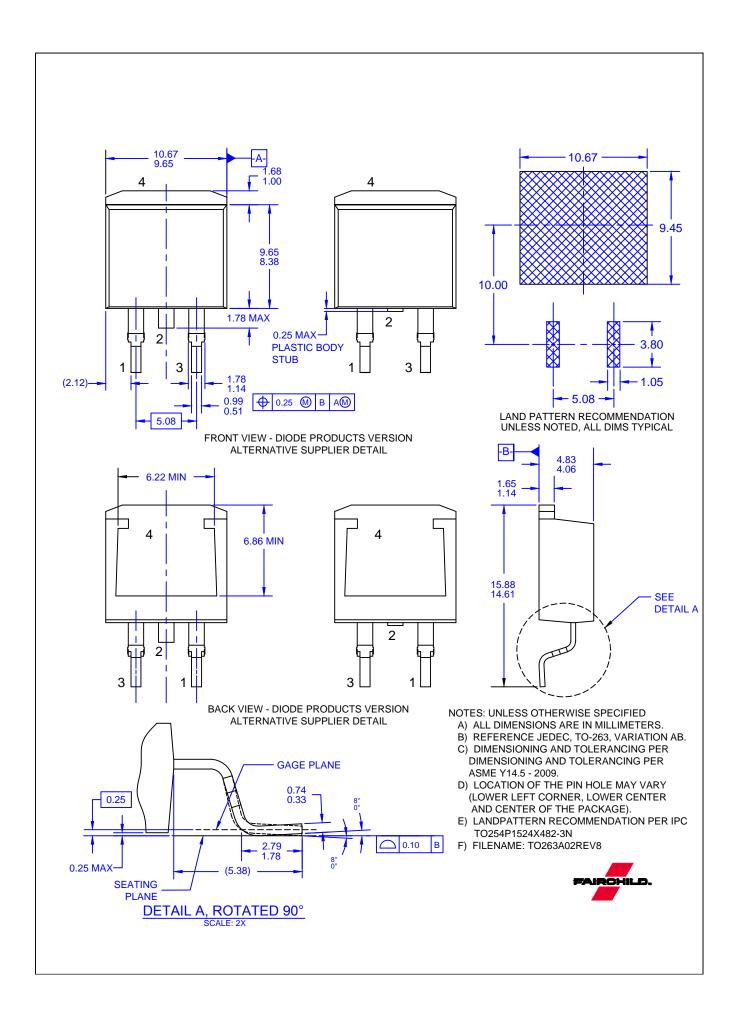
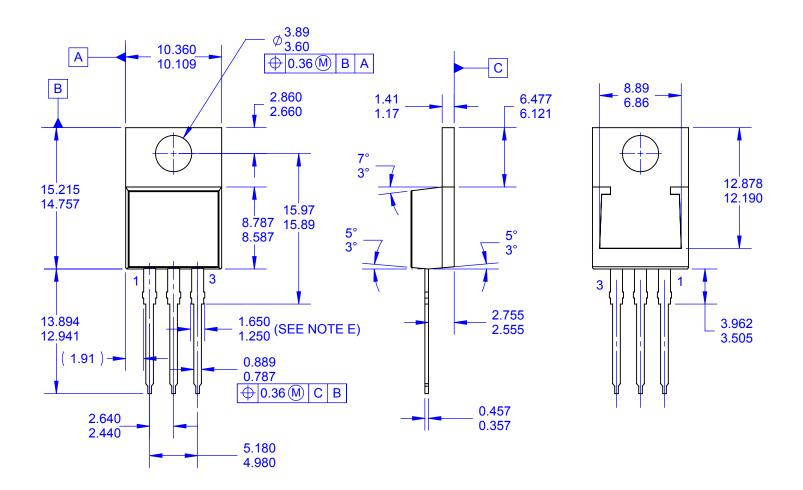
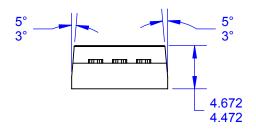


Figure 17. Peak Diode Recovery dv/dt Test Circuit & Waveforms







NOTES:

- A. PACKAGE REFERENCE: JEDEC TO220 **VARIATION AB**
- B. ALL DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.
- D. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.
- E. MAX WIDTH FOR F102 DEVICE = 1.35mm. F. DRAWING FILE NAME: TO220T03REV4.
- G. FAIRCHILD SEMICONDUCTOR.





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Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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